

## REMARKS

In the Office Action, the Examiner rejected claims 1, 3, 4, 20-22, 57, 58 and 72 under 35 USC 102. These rejections are fully traversed below.

Claims 1, 5, 8, 20, 24, 30, 58 and 63 have been amended. Claims 73 and 74 have been added. Claims 3, 4 and 57 have been cancelled. Thus, claims 1, 5-9, 12-16, 18-31, 58 and 63-74 are pending in the application. Reconsideration of the application is respectfully requested based on the following remarks.

### ***Claim Rejections – 35 USC 102***

**Claims 1, 3, 4, 20-22, 57, 58 and 72 have been rejected under 35 U.S.C. 102(b) as being anticipated by *Terakawa* (U.S. Pat. No. 5,008,486).**

Claims 3, 4 and 57 were cancelled.

In contrast to *Terakawa*, claim 1 (and its dependents) specifically requires, "...a housing for enclosing internal components of the portable computing device that provide computing operations for the portable computing device..." *Terakawa* does not disclose a portable computing device. *Terakawa* is directed at electromagnetic wave shielding panels and wall structure which are suitable for use in forming electromagnetic wave shielding rooms. Shielding rooms are simply not computing devices. Moreover, shielding rooms as disclosed in *Terakawa* are not portable. Accordingly, the rejection is unsupported by the art and should be withdrawn.

Also in contrast to *Terakawa*, claim 1 specifically requires, "...a singular composite structure that both supports the portable computing device and shields the portable computing device from electronic emissions." While *Terakawa* may disclose an adhesive for applying a conductive foil to joints between adjacent panels (Col. 3, lines 65-68), it would simply not function to support the shielding panels as required by claim 1. As should be appreciated, the adhesive is not applied between the shielding panels and foils are inherently flimsy and may

even rip if a sufficient force is applied thereto. In *Terakawa*, the plate members 20 and 30 are connected using a wedge 10 or ridge 13 (see Figs. 3-7). *Terakawa* states, “The size and shape of the wedge member 10 are determined so as to cause generation of sufficient holding force upon insertion of the wedge member in the opposite slots of the adjacent panels 20 (Col. 5, lines 46-50).” *Terakawa* also states, “These male and female structures take the place of the wedging member 10, which otherwise, would be used in integrally connecting the adjacent panels (Col. 6, lines 10-14).” Accordingly, the rejection is unsupported by the art and should be withdrawn.

Also in contrast to *Terakawa*, claim 20 specifically requires, “wherein the conductive bridge is formed from a conductive paste. *Terakawa* is completely silent to a conductive paste. The most that can be said is that *Terakawa* teaches a conductive foil that is applied to the joints between adjacent panels by using an adhesive. This however, is not a conductive paste. Accordingly, the rejection is unsupported by the art and should be withdrawn.

#### ***Allowable Subject Matter***

Claims 9-16, 18, 19 and 31 have been allowed. In addition, allowed claim 5 was amended to include the limitations of independent claim 1 and intervening claim 4, allowed claim 8 was amended to include the limitations of independent claim 1, allowed claim 24 was amended to include the limitations of independent claim 20, allowed claim 30 was amended to include the limitations of independent claim 20, and allowed claim 63 was amended to include the limitations of independent claim 57. Claims 5, 8, 24, 30 and 63 (as well as their dependents) are therefore allowable as the Examiner indicated allowable subject matter in the previous Office Action.

**SUMMARY**

Applicant believes that all pending claims are allowable and respectfully requests a Notice of Allowance for this application from the Examiner. Should the Examiner believe that a telephone conference would expedite the prosecution of this application, the undersigned can be reached at the telephone number set out below.

Respectfully submitted,  
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